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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Tao Deng et al.
Serial No: Not Yet Assigned
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For: FABRICATION OF METALLIC MICROSTRUCTURES
VIA EXPOSURE OF PHOTORESISTIVE COMPOSITION

Examiner: Not Yet Assigned
Art Unit: Not Yet Assigned

Mail Stop Patent Application
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

PRELIMINARY AMENDMENT

Sir:

Please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims that begins on page 2 of this amendment.

Conclusion begins on page 5 of this amendment.

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